

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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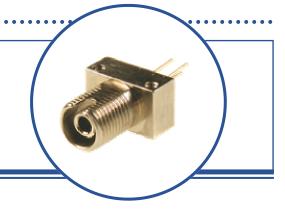


Vertical Cavity Surface Emitting Laser in FC Optical Sub-Assembly



OPV314F, OPV314YF, OPV315F, OPV315YF

- 850 nm VCSEL technology, up to 2.5 Gbps data rate
- · High thermal stability with Microbead lens
- High optical coupling to MM fiber with FC style receptacle
- Recommended for multimode fiber applications
- Burned in for communication level reliability



The OPV31XF and OPV31XYF are a high performance 850nm Vertical Cavity Surface Emitting Laser (VCSEL) packaged for high speed communication links. OPV31XF combines all the performance advantages of a VCSEL with the addition of a power monitor diode for precise control of optical power. The VCSEL is a current device assuming the forward voltage drop, from 1.6 to 2.2 volts, is achieved.

The OPV31XF and OPV31XYF are electrically and optically identical, they differ only in pin out. Refer to the charts below.

The OPV315 devices have an attenuation coating on the interior surface of the lens. The coating reflects about 40% of the light reducing noise in special applications, preventing overdriving of sensitive detectors and doubling monitor current.

These product's include a combination of features including high speed with high output power and a concentric beam there by making it an ideal transmitter for integration into all types of data communications equipment.

Applications include:

- Fibre Channel
- Gigabit Ethernet
- ATM
- VSR (Very Short Reach)
- Intra-system links
- Optical backplane interconnects.



Additional laser safety information can be found on the Optek website. See application #221. Classification is not marked on the device due to space limitations. See package outline for centerline of optical radiance. Operating devices beyond maximum rating may cause devices to exceed rated classification

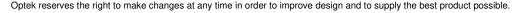
Ordering Information

Please order part number:

OPV314F—Common VCSEL Cathode / Pin Diode Anode OPV314YF—Common VCSEL Anode / Pin Diode Cathode OPV315F—Common VCSEL Cathode / Pin Diode Anode, Attenuated Power OPV315YF—Common VCSEL Anode / Pin Diode Cathode1, Attenuated Power

OPV314F, OPV315F		
Pin	Connection	
1	VCSEL Anode	
2	VCSEL Cathode/PD Anode	
3	PD Cathode	

OPV314YF, OPV315YF		
Pin	Connection	
1	VCSEL Cathode	
2	VCSEL Anode/PD Cathode	
3	PD Anode	







Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Storage Temperature	-40° C to +100° C
Operating Temperature	0° C to +70° C
Maximum Forward Peak Current	20 mA
Maximum Reverse Voltage	10 V
Lead Soldering Temperature (1/16" (1.6mm) from case for 5 seconds with soldering iron)	260° C ⁽¹⁾

Electrical Characteristics (T_A = 25°C unless otherwise noted)

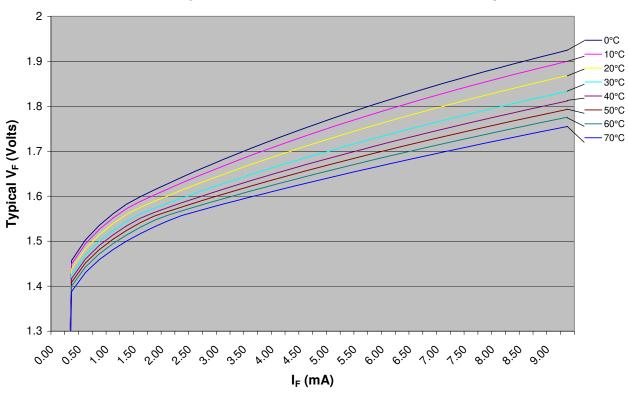
SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITION
P _{T50}	Total Coupled Power (OPV314, OPV314Y) (OPV315, OPV315Y)				μW	$I_F = 7 \text{ mA},$
1 150					μW	Fiber 50/125μm
I_{TH}	Threshold Current	0.8		3.0	mA	Note1
V_{F}	Forward Voltage	1.6		2.2	>	$I_F = 7 \text{ mA}$
I _R	Reverse Current			35	nA	$V_R = 5 V$
Rs	Series Resistance	20		55	ohms	Note 2
η	Slope Efficiency (OPV314, OPV314Y)	50			μ W /mA	Note 2
'((OPV315, OPV315Y)	25			μW/mA	Note 3
I _{RPD}	Reverse Current, photo diode			30	nA	V _R = 40 V
I _M	Monitor Current (OPV314, OPV314Y)	50			μA	1 7 A M
	(OPV315, OPV315Y)	100			μA	$I_F = 7 \text{ mA}, V_R = 5 \text{ V}$
λ	Wavelength	840		860	nm	
Δλ	Optical Bandwidth			0.85	nm	
t _r	Rise Time		90		ps	20% to 80%
t _f	Fall Time		120		ps	80% to 20%
N _{RI}	Relative Intensity Noise		-123		db/Hz	
Δη/ΔΤ	Temp Coefficient of Slope Efficiency		-0.4		%/°C	(0° - 70° C)
$\Delta I_{TH}/\Delta T$	Temp Coefficient of Threshold Current		±0.1		mA	0° - 70° C
Δλ/ΔΤ	Temp Coefficient of Wavelength		0.06		nm/°C	0° - 70° C
ΔVf/ΔT	Temperature Coefficient for VF		-2.5		mV/°C	

NOTES

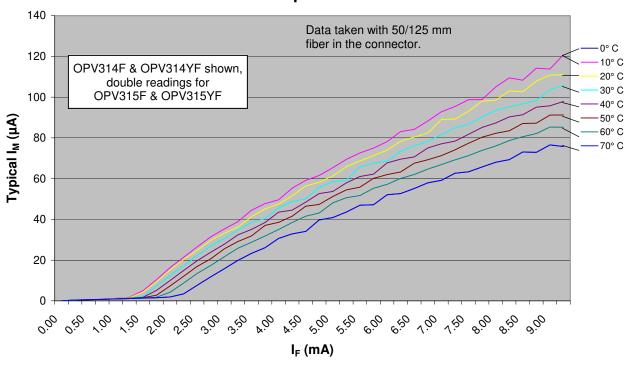
- (1) Threshold Current is based on the two line intersection method specified in Telcordia GR-468-Core. Line 1 from 4 mA to 6 mA. Line 2 from 0 mA to 0.5 mA.
- (2) Series Resistance is the slope of the Voltage-Current line from 5 to 8 mA.
- (3) Slope efficiency, is the slope of the best fit LI line from 5 mA to 8 mA using no larger than .25 mA test interval points. Measured with a 50/125 μm fiber.
- (4) Linearity—Using data points taken for slope efficiency above, data L/delta I shall be calculated for each adjacent pair of points.



Forward Voltage (V_F) vs Forward Current (I_F) vs Temperture

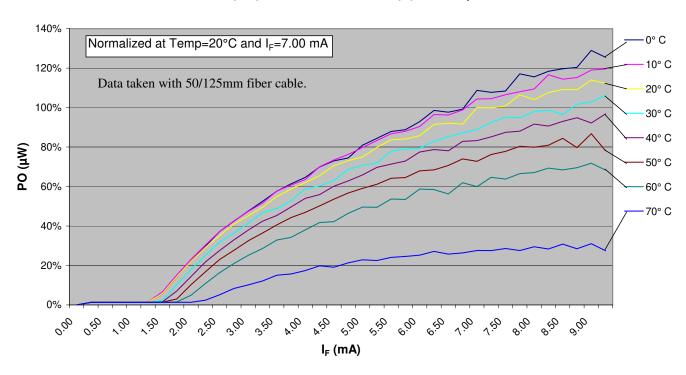


Monitor Diode Current (I_M) vs Forward Current (I_F) vs Temperature

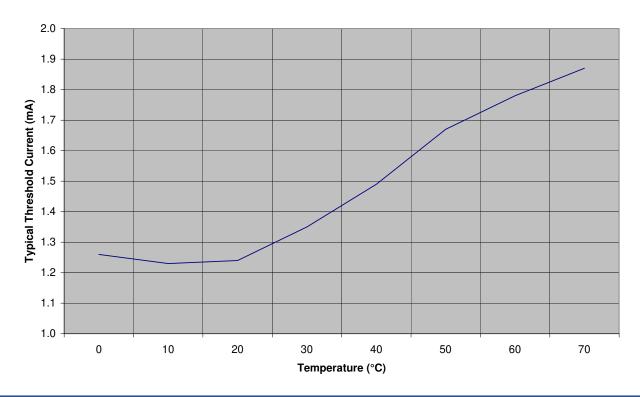




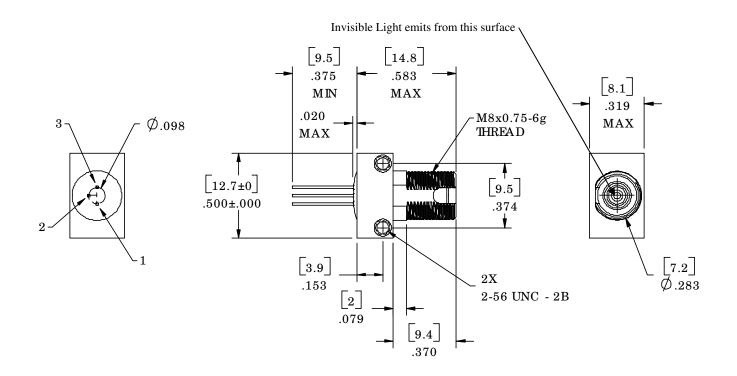
Power Out (PO) vs Forward Current (I_F) vs Temperature



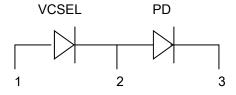
Threshold vs Temperature



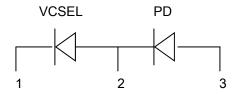




DIMENSIONS ARE IN [MILIMITERS] AND INCHES.



OPV314F, OPV315F		
Pin	Connection	
1	VCSEL Anode	
2	VCSEL Cathode/PD Anode	
3	PD Cathode	



OPV314YF, OPV315YF		
Pin	Connection	
1	VCSEL Cathode	
2	VCSEL Anode/PD Cathode	
3	PD Anode	